

L8	2189111	chip die package dice ic integrat\$4 adj circuit	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/24 19:05
L9	1098299	adhesiv\$4 glue	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/24 19:07
L10	7830	solder near2 mask\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/24 19:07
L11	171	5 and 8 and 9 and 10	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/24 19:08
L12	156	11 and (@ad < "20030919")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/24 19:08
L13	4068	((257/684) or (257/690) or (257/698) or (257/793)).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/08/24 19:25
S96	2	"20050073035".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/24 17:13
S97	1	S96 and (resist photoresist)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/24 18:23

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	36	US-6020629-\$.DID. OR US-6153924-\$.DID. OR US-6229202-\$.DID. OR US-6310390-\$.DID. OR US-6326242-\$.DID. OR US-6326244-\$.DID. OR US-6355199-\$.DID. OR US-6462274-\$.DID. OR US-6465877-\$.DID. OR US-6482674-\$.DID. OR US-6489557-\$.DID. OR US-6509643-\$.DID. OR US-6506625-\$.DID. OR US-6506626-\$.DID. OR US-6507114-\$.DID. OR US-6534848-\$.DID. OR US-6537857-\$.DID. OR US-6544812-\$.DID.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/24 18:23
L2	18	US-6020629-\$.DID. OR US-6153924-\$.DID. OR US-6229202-\$.DID. OR US-6310390-\$.DID. OR US-6326242-\$.DID. OR US-6326244-\$.DID. OR US-6355199-\$.DID. OR US-6462274-\$.DID. OR US-6465877-\$.DID. OR US-6482674-\$.DID. OR US-6489557-\$.DID. OR US-6509643-\$.DID. OR US-6506625-\$.DID. OR US-6506626-\$.DID. OR US-6507114-\$.DID. OR US-6534848-\$.DID. OR US-6537857-\$.DID. OR US-6544812-\$.DID.	USPAT	OR	ON	2005/08/24 18:27

L3	19	US-6020629-\$.DID. OR US-6153924-\$.DID. OR US-6229202-\$.DID. OR US-6310390-\$.DID. OR US-6326242-\$.DID. OR US-6326244-\$.DID. OR US-6355199-\$.DID. OR "6396141". pn. or US-6462274-\$.DID. OR US-6465877-\$.DID. OR US-6482674-\$.DID. OR US-6489557-\$.DID. OR US-6509643-\$.DID. OR US-6506625-\$.DID. OR US-6506626-\$.DID. OR US-6507114-\$.DID. OR US-6534848-\$.DID. OR US-6537857-\$.DID. OR US-6544812-\$.DID.	USPAT	OR	ON	2005/08/24 18:29
L4	21	US-6020629-\$.DID. OR US-6153924-\$.DID. OR US-6229202-\$.DID. OR US-6310390-\$.DID. OR US-6326242-\$.DID. OR US-6326244-\$.DID. OR US-6355199-\$.DID. OR "6396141". pn. or US-6462274-\$.DID. OR US-6465877-\$.DID. OR US-6482674-\$.DID. OR US-6489557-\$.DID. OR US-6509643-\$.DID. OR US-6506625-\$.DID. OR US-6506626-\$.DID. OR US-6507114-\$.DID. OR US-6534848-\$.DID. OR US-6537857-\$.DID. OR US-6544812-\$.DID. or "6552427". pn. or "6459144".pn.	USPAT	OR	ON	2005/08/24 18:29
L5	24180	stiffener	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/24 18:40
L6	11	4 and 5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/24 18:49
L7	2	6 and (resist photoresist pr)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/24 19:04